



US 20140167196A1

(19) **United States**(12) **Patent Application Publication**
Heimgartner et al.(10) **Pub. No.: US 2014/0167196 A1**(43) **Pub. Date: Jun. 19, 2014**(54) **OPTICAL MODULES INCLUDING FOCAL LENGTH ADJUSTMENT AND FABRICATION OF THE OPTICAL MODULES**

(60) Provisional application No. 61/772,073, filed on Mar. 4, 2013, provisional application No. 61/721,747, filed on Nov. 2, 2012.

(71) Applicant: **Heptagon Micro Optics Pte. Ltd.,**
Singapore (SG)**Publication Classification**(72) Inventors: **Stephan Heimgartner**, Aarau Rohr (CH); **Ville Kettunen**, Rueschlikon (CH); **Nicola Spring**, Ziegelbruecke (CH); **Alexander Bietsch**, Thalwil (CH); **Mario Cesana**, AU (CH); **Hartmut Rudmann**, Jona (CH); **Jukka Alasirnio**, Jaali (FI); **Robert Lenart**, Zurich (CH)(51) **Int. Cl.**
H01L 27/146 (2006.01)
H01L 31/18 (2006.01)
(52) **U.S. Cl.**
CPC **H01L 27/14625** (2013.01); **H01L 31/18** (2013.01)
USPC **257/432; 438/65**(73) Assignee: **Heptagon Micro Optics Pte. Ltd.,**
Singapore (SG)(21) Appl. No.: **14/177,552**(22) Filed: **Feb. 11, 2014****Related U.S. Application Data**

(63) Continuation of application No. 14/064,550, filed on Oct. 28, 2013.

(57) **ABSTRACT**

Fabricating optical devices can include mounting a plurality of singulated lens systems over a substrate, adjusting a thickness of the substrate below at least some of the lens systems to provide respective focal length corrections for the lens systems, and subsequently separating the substrate into a plurality of optical modules, each of which includes one of the lens systems mounted over a portion of the substrate. Adjusting a thickness of the substrate can include, for example, micro-machining the substrate to form respective holes below at least some of the lens systems or adding one or more layers below at least some of the lens systems so as to correct for variations in the focal lengths of the lens systems.

